MOSFET - Power, Single N-Channel, PQFN8 5x6 150 V, 11.5 mΩ, 78 A

NTMFS011N15MC

Features

- Small Footprint (5 x 6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Synchronous Rectification
- AC-DC and DC-DC Power Supplies
- AC-DC Adapters (USB PD) SR
- Load Switch

MAXIMUM RATINGS ($T_J = 25^{\circ}C$, Unless otherwise specified)

Para	Parameter		Symbol	Value	Unit
Drain-to-Source Breakdown Voltage		V _{(BR)DSS}	150	V	
Gate-to-Source Volta	Gate-to-Source Voltage		V_{GS}	±20	V
Continuous Drain Current $R_{\theta JC}$ (Note 2)	Steady State	T _C = 25°C	I _D	78	Α
Power Dissipation R _{θJC} (Note 2)			P _D	147	W
Continuous Drain Current $R_{\theta JA}$ (Note 1, 2)	Steady State	T _A = 25°C	I _D	10.7	Α
Power Dissipation $R_{\theta JA}$ (Note 1, 2)			P _D	2.7	W
Pulsed Drain Cur- rent	$T_A = 25^{\circ}C, t_p = 250$ µs		I _{DM}	259	Α
Operating Junction and Storage Temperature		T _J , T _{stg}	–55 to +150	°C	
Source Current (Body Diode)		I _S	133	Α	
Single Pulse Drain-to-Source Avalanche Energy (I _{AV} = 39 A, L = 0.1 mH)		E _{AS}	76.1	mJ	
Lead Temperature Soldering Reflow for Soldering Purposes (1/8" from case for 10 s)		TL	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Surface-mounted on FR4 board using 1 in² pad size, 1 oz Cu pad.
- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

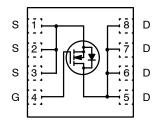


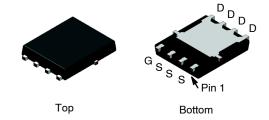
ON Semiconductor®

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V _{(BR)DSS}	V _{(BR)DSS} R _{DS(ON)} MAX	
150 V	11.5 mΩ @ 10 V	35 A
	13.2 mΩ @ 8 V	18 A

N-Channel MOSFET





PQFN8 5x6 (Power 56) CASE 483AE

MARKING DIAGRAM



A = Assembly Location

Y = Year W = Work

W = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

THERMAL CHARACTERISTICS

Symbol	Parameter	Max	Unit
$R_{ heta JC}$	Junction-to-Case – Steady State (Note 5)		°C/W
$R_{ hetaJA}$	Junction-to-Ambient - Steady State (Note 5)	46	

ORDERING INFORMATION

Device	Device Marking	Package	Shipping (Qty / Packing) [†]
NTMFS011N15MC	NTMFS011N15MC	PQFN8 5x6 (Power 56) (Pb-Free/Halogen Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions		Min	Тур	Max	Unit
OFF CHARAC	TERISTICS						
V _{(BR)DSS}	Drain – to – Source Breakdown Voltage	$V_{GS} = 0 \text{ V, I}_{D} = 250 \mu\text{A}$		150			V
V _{(BR)DSS} / T _J	Drain – to – Source Breakdown Voltage Temperature Coefficient	I _D = 250 μA, ref to	25°C		85		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V 0VV 100V	T _J = 25°C			1	μΑ
		$V_{GS} = 0 \text{ V}, V_{DS} = 120 \text{ V}$	T _J = 125°C			100	
I_{GSS}	Gate – to – Source Leakage Current	V _{DS} = 0 V, V _{GS} = 3	±20 V			±100	nA
ON CHARACT	ERISTICS (Note 3)						
V _{GS(TH)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 19$	94 μΑ	2.5	3.35	4.5	V
V _{GS(TH)} / I _J	Negative Threshold Temperature Coefficient	I _D = 250 μA, ref to 25°C			-7.2		mV/°C
R _{DS(on)}	Drain – to – Source On Resistance	V _{GS} = 10 V, I _D = 3	35 A		9.0	11.5	mΩ
		V _{GS} = 8 V, I _D = 18 A			9.7	13.2	1
g _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 18 A			96	116	S
R _G	Gate-Resistance	T _A = 25°C			0.9	1.1	Ω
CHARGES & C	CAPACITANCES						
CISS	Input Capacitance				2478	3592	pF
Coss	Output Capacitance	V _{GS} = 0 V, f = 1 MHz, \	_{DS} = 75 V		728	1092	1
CRSS	Reverse Transfer Capacitance				7.9	15	1
Q _{G(TOT)}	Total Gate Charge	V _{GS} = 8 V, V _{DS} = 75 V, I _D = 35 A			30.6	46	nC
Q _{G(TOT)}	Total Gate Charge				30.7	46	1
Q _{GS}	Gate-to-Source Charge	.,	/ L 05 A		12.8		1
Q _{SW}	Switching Charge	$V_{GS} = 10 \text{ V}, V_{DS} = 75 \text{ V}, I_{D} = 35 \text{ A}$ $V_{GS} = 0 \text{ V}, V_{DD} = 75 \text{ V}$			9.4		1
Q _{GD}	Gate-to-Drain Charge				4.5		1
Qoss	Output Charge				95		1
V _{GP}	Plateau Voltage	V _{GS} = 10 V, V _{DS} = 75 V, I _D = 35 A			5.1		V
SWITCHING C	HARACTERISTICS (Note 3)				-	-	•
t _{d(ON)}	Turn – On Delay Time				19.8		ns
t _r	Rise Time	V_{GS} = 10 V, V_{DS} = 75 V, I_D = 35 A, R_G = 6 Ω			4.7		1
t _{d(OFF)}	Turn – Off Delay Time				25.5		1
t _f	Fall Time				4.0		1

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted) (continued)

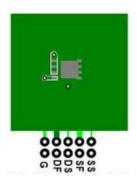
Symbol	Parameter	Test Conditions		Min	Тур	Max	Unit	
DRAIN-SOURCE DIODE CHARACTERISTICS								
V _{SD}	Forward Diode Voltage	$V_{GS} = 0 \text{ V, } I_S = 35 \text{ A}$	T _J = 25°C		0.869		V	
			T _J = 125°C		0.725			
t _{RR}	Reverse Recovery Time	V_{GS} = 0 V, dI _S /dt = 300 A/ μ s, I _S = 35 A			48.8		ns	
Q _{RR}	Reverse Recovery Charge				227		nC	
t _{RR}	Reverse Recovery Time	$V_{GS} = 0 \text{ V, dI}_S/\text{dt} = 1000 \text{ A/}\mu\text{s,}$ $I_S = 35 \text{ A}$			36.4		ns	
Q_{RR}	Reverse Recovery Charge				407		nC	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

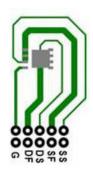
3. Switching characteristics are independent of operating junction temperatures.

NOTES:

4. $R_{\theta JA}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta CA}$ is determined by the user's board design.



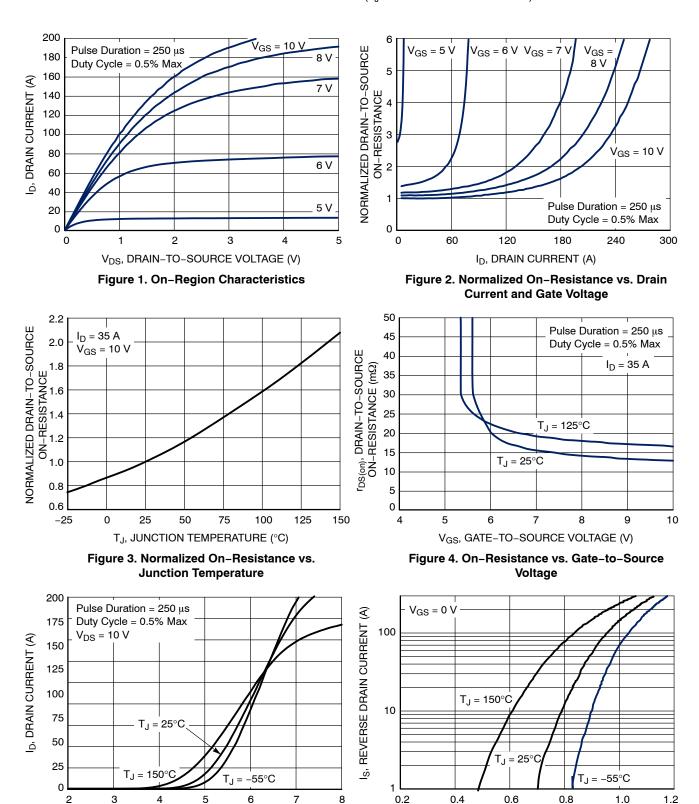
a) 46°C/W when mounted on a 1 in² pad of 2 oz copper.



b) 116°C/W when mounted on a minimum pad of 2 oz copper.

- Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.
 E_{AS} of 196 mJ is based on starting T_J = 25°C; L = 3 mH, I_{AS} = 12.7 A, V_{DD} = 100 V, V_{GS} = 15 V. 100% tested at L = 0.1 mH, I_{AS} = 41 A.
 Pulsed I_D please refer to Fig 11 SOA graph for more details.
 Compute Continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

TYPICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted.)



V_{SD}, BODY DIODE FORWARD VOLTAGE (V)

Figure 6. Source-to-Drain Diode Forward Voltage vs. Source Current

V_{GS}, GATE-TO-SOURCE VOLTAGE (V)

Figure 5. Transfer Characteristics

TYPICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise noted.)

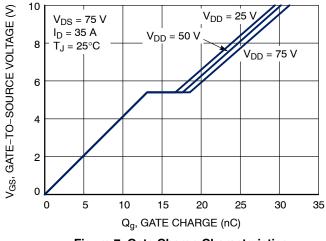


Figure 7. Gate Charge Characteristics

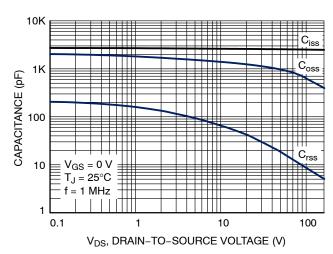


Figure 8. Capacitance vs. Drain-to-Source Voltage

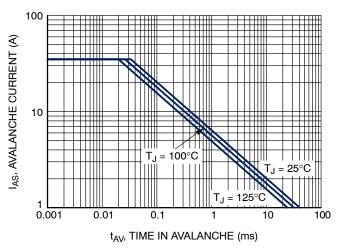


Figure 9. Unclamped Inductive Switching Capability

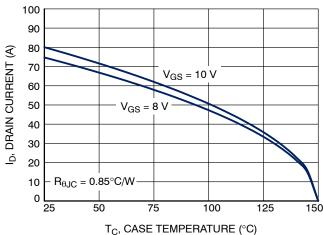


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

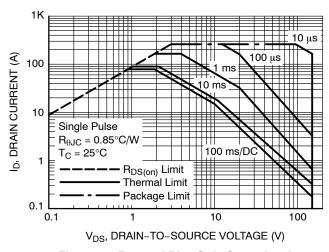


Figure 11. Forward Bias Safe Operating Area

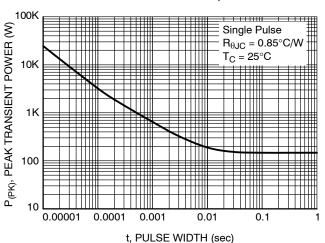


Figure 12. Single Pulse Maximum Power Dissipation

TYPICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted.)

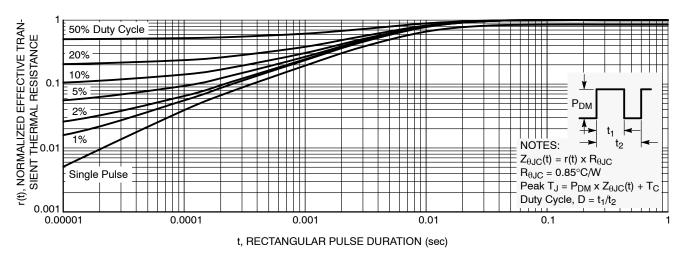
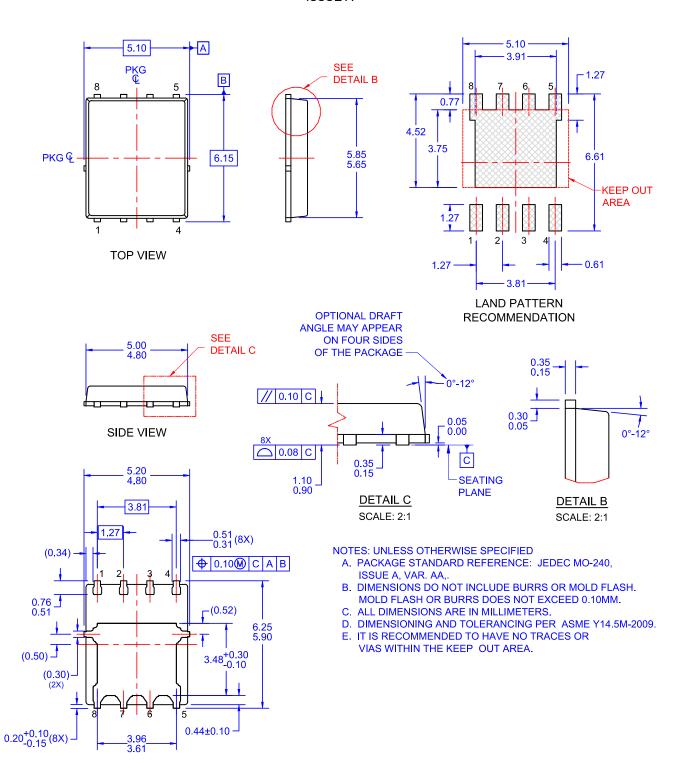


Figure 13. Junction-to-Case Transient Thermal Response Curve

PACKAGE DIMENSIONS

PQFN8 5X6, 1.27P CASE 483AE ISSUE A



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